Product data sheet

1. Product profile

1.1 General description

The BB178 is a planar technology variable capacitance diode, in a SOD523 (SC-79) ultra small plastic package. The excellent matching performance is achieved by gliding matching and a Direct Matching Assembly (DMA) procedure.

1.2 Features and benefits

- Excellent linearity
- Excellent matching to 2 % DMA
- Ultra small plastic SMD package
- $C_{d(28V)}$: 2.6 pF; $C_{d(1V)}$ to $C_{d(28V)}$ ratio: 15
- Very low series resistance.

1.3 Applications

- Electronic tuning in VHF television tuners, band B up to 460 MHz
- Voltage Controlled Oscillators (VCO).

2. Pinning information

Table 1. Pinning

Pin	Description	Simplified outline[1]	Symbol
1	cathode		Ш
2	anode	1 2	sym008

^[1] The marking bar indicates the cathode.

3. Ordering information

Table 2. Ordering information

Type number	Package				
	Name	Description	Version		
BB178	SC-79	plastic surface mounted package; 2 leads	SOD523		



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4. Marking

Table 3. Marking

Type number	Marking code
BB178	8

5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

		• • •	,		
Symbol	Parameter	Conditions	Min	Max	Unit
V_{R}	reverse voltage		-	32	V
V_{RM}	peak reverse voltage	in series with a $10 \text{ k}\Omega$ resistor	-	35	V
I _F	forward current		-	20	mA
T _{stg}	storage temperature		-55	+150	°C
T _j	junction temperature		-55	+125	°C

6. Characteristics

Table 5. Characteristics

 $T_i = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions	Mi	n Typ	Max	Unit
I_R	reverse current	see Figure 2				
		$V_R = 30 \text{ V}$	-	-	10	nA
		$V_R = 30 \text{ V}; T_j = 85 ^{\circ}\text{C}$	-	-	200	nA
r _s	diode series resistance	f = 100 MHz	[1] -	0.65	0.8	Ω
C _d diode capacitance		f = 1 MHz; see <u>Figure 1</u> and <u>Figure 3</u>				
		$V_R = 1 V$	34	.65 -	42.35	pF
		V _R = 28 V	2.3	361 2.6	2.754	pF
$\frac{C_{d(1V)}}{C_{d(2V)}}$	capacitance ratio	f = 1 MHz	-	1.3	-	
$\frac{C_{d(1V)}}{C_{d(28V)}}$	capacitance ratio	f = 1 MHz	13	.5 15	-	
$\frac{C_{d(25V)}}{C_{d(28V)}}$	capacitance ratio	f = 1 MHz	-	1.08	-	
$\frac{\Delta C_d}{C_d}$	capacitance matching	$V_R = 1 \text{ V to } 28 \text{ V; in a}$ sequence of 10 diodes (gliding)	-	-	2	%

^[1] V_R is the value at which $C_d = 30$ pF.

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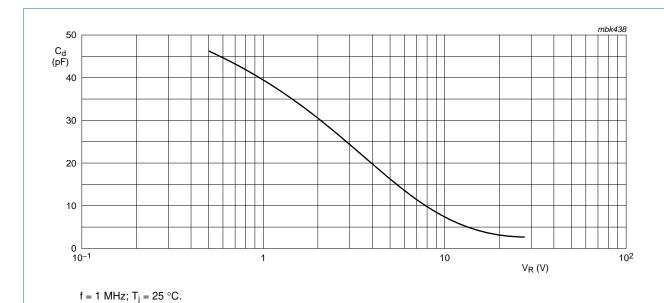


Fig 1. Diode capacitance as a function of reverse voltage; typical values.

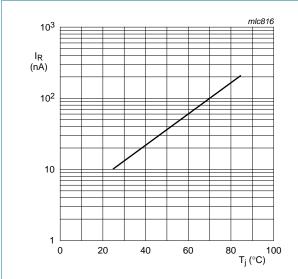
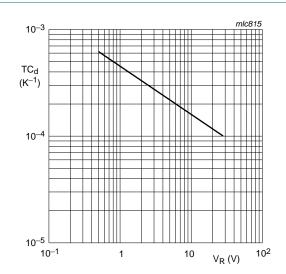


Fig 2. Reverse current as a function of junction temperature; maximum values.



 $T_i = 0$ °C to 85 °C.

Fig 3. Temperature coefficient of diode capacitance as a function of reverse voltage; typical values.

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7. Package outline

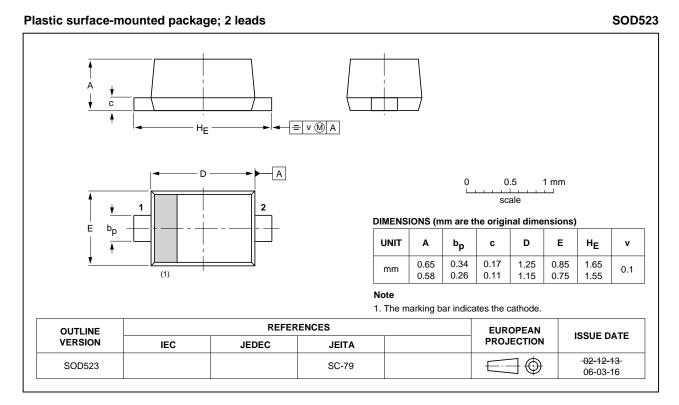


Fig 4. Package outline SOD523 (SC-79).

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8. Revision history

Table 6. Revision history

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Document ID	Release date	Data sheet status	Change notice	Supersedes
BB178 v.3	20110905	Product data sheet	-	BB178 v.2
Modifications:	guidelines o • Legal texts	of this data sheet has been of NXP Semiconductors. have been adapted to the no utline drawings have been up	ew company name whe	ere appropriate.
BB178 v.2 (9397 750 13831)	20041103	Product data sheet	-	BB178 v.1
BB178 v.1 (9397 750 02982)	19971113	Product specification	-	-

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9. Legal information

9.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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